



Notes:

1. Materials:
 - 1.1 Contact: copper alloy, t=0.20mm.
 - 1.2 Shell: copper alloy, t=0.25mm.
 - 1.3 Housing: High temperature thermoplastic with g.f, UL94 v-0.
2. Specifications:
 - 2.1. Current rating: 1 A Max.
 - 2.2. Dielectric withstanding: voltage: 100 V(ac) for 1 min.
 - 2.3. Contact resistance: 50 mW Max.
 - 2.4. Insulation resistance: 100 MW Min.
 - 2.5. Total mating force: 3.57 Kgf Max.
 - 2.6. Total unmating force: 1.0 Kgf Min, 0.81~2.05 Kgf Min, after 10000 insertion/extraction cycles
 - 2.7. Temperature range: -30° C~+80° C

UNITS:	mm	CSCONN		CSCONN PRECISE ELECTRONICS CO.,LTD	
GENERAL TOLERANCE:		PART NO.(INTENDED USE)		TITLE:	
K° ±5°	0.1±0.25	CMU065515003		MICRO USB 5P DIP90 C TYPE	
K.1 ±2°	0.1V±0.1	APPD:	SK11a	DWG NO.	MICRO USB
KX ±1°		CHKD:	Skilla	SCALE	SHEET
		DR:	Kitty	1:1	1 OF 1
					REV
					A